<table>
<thead>
<tr>
<th>Symbol</th>
<th>Hit Count</th>
<th>Tool Size</th>
<th>Plated</th>
<th>Hole Type</th>
</tr>
</thead>
<tbody>
<tr>
<td>⊗</td>
<td>39</td>
<td>12mil (0.305mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>*</td>
<td>6</td>
<td>39.37mil (1mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td>▼</td>
<td>10</td>
<td>50mil (1.27mm)</td>
<td>PTH</td>
<td>Round</td>
</tr>
<tr>
<td></td>
<td>55 Total</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Drill Table

![Drill Table Diagram]
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